



NPN/PNP SILICON COMPLEMENTARY SMALL SIGNAL DUAL TRANSISTOR

Qualified per MIL-PRF-19500/421

Qualified Levels: JAN, JANTX, and **JANTXV**

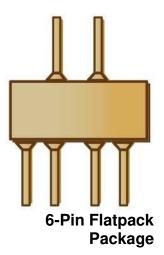
DESCRIPTION

This 2N3838 device in a 6-pin Flatpack package is military qualified up to a JANTXV level for high-reliability applications. Microsemi also offers numerous other products to meet higher and lower power voltage regulation applications.

Important: For the latest information, visit our website http://www.microsemi.com.

FEATURES

- JAN, JANTX, and JANTXV qualifications also available per MIL-PRF-19500/421.
- RoHS compliant versions available (commercial grade only).



APPLICATIONS / BENEFITS

- Two complementary small signal silicon transistors in a single package design.
- Lightweight.

Also available in:



芃 TO-78 package

(leaded) 2N4854



🄁 6-Pin U package (surface mount) 2N4854U

MAXIMUM RATINGS

Parameters/Test Conditions	Symbol	Value per		Unit
		Each Transistor	Total Package	
Thermal Resistance Junction-to-Case	Rejc	250	125	ºC/W
Thermal Resistance Junction-to-Ambient	R _{OJA}	350	290	ºC/W
Total Power Dissipation @ $T_A = +25 ^{\circ}C^{(1)}$	P _T	0.25	0.35	W
Total Power Dissipation @ T _C = +25 °C (2)	P _T	0.7	1.4	W
Junction and Storage Temperature	T_J and T_{STG}	-65 to +200		°C
Collector-Base Voltage, Emitter Open	V _{CBO}	60		V
Emitter-Base Voltage, Collector Open	V _{EBO}	5		V
Collector-Emitter Voltage, Base Open	V _{CEO}	40		V
Collector Current, dc	I _C	600		mA
Lead to Case Voltage		+/- 120		V
Solder Temperature @ 10 s	T _{SP}	260		°C

Notes: 1. For T_A > +25 °C, derate linearly 1.43 mW/°C one transistor, 2.00 mW/°C both transistors.

2. For T_C > +25 °C, derate linearly 4.0 mW/°C one transistor, 8.0 mW/°C both transistors.

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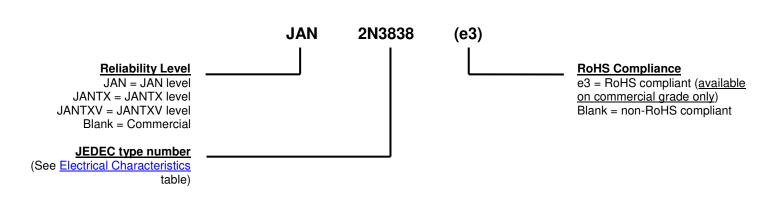
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MECHANICAL and PACKAGING

- CASE: Hermetic ceramic (white), Au over Ni plated kovar cover.
- TERMINALS: Au over Ni plated copper.
- MARKING: Manufacturer's ID, part number, date code, Pin 1 Identifier.
- POLARITY: See Case Outline.
- See <u>Package Dimensions</u> on last page.

PART NOMENCLATURE



SYMBOLS & DEFINITIONS					
Symbol	Definition				
Ι _Β	Base Current, dc.				
Ic	Collector Current, dc.				
I _E	Emitter Current, dc.				
lo	Average Rectified Output Current: The Output Current averaged over a full cycle with a 50 Hz or 60 Hz sine-wave input and a 180 degree conduction angle.				
V _{CB}	Collector-Base Voltage (dc).				
V _{CE}	Collector-Emitter Voltage, dc.				
V _{EB}	Emitter-Base Voltage (dc).				

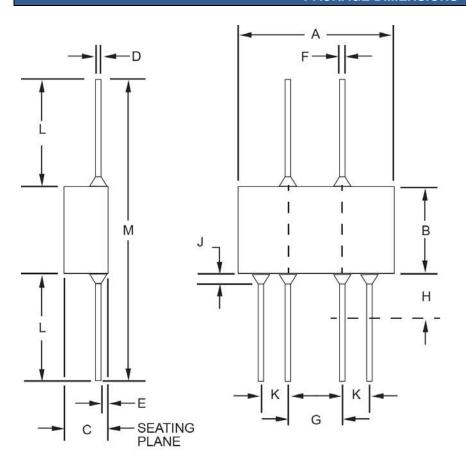


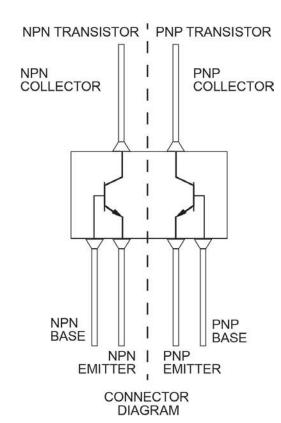
ELECTRICAL CHARACTERISTICS @ T_A= 25 ^oC unless otherwise noted.

Characteristics	Symbol	Min.	Max.	Unit
OFF CHARACTERISTICS				
Collector-Emitter Breakdown Current	V _{(BR)CEO}	40		V
$I_C = 10 \text{ mA (pulsed)}$	V (BR)CEO	40		V
Collector-Base Cutoff Current	1		10	
$V_{EB} = 5 \text{ V}$	I _{CBO(1)}		10	μΑ
Collector-Base Cutoff Current	1		50	Λ
$V_{CB} = 50 \text{ V}$	I _{CBO(2)}		50	nA
Emitter-Base Cutoff Current				
$V_{EB} = 5.0 \text{ V}$	I _{EBO(1)}		10	μΑ
$V_{EB} = 3.0 \text{ V}$	I _{EBO(2)}		10	nA
ON CHARACTERISTICS				
Forward-Current Transfer Ratio				
$I_C = 150 \text{ mA}, V_{CE} = 1 \text{ V}$	h _{FE}	50		
$I_C = 100 \mu A, V_{CE} = 10 V$		35		
$I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}$		50		
$I_C = 10 \text{ mA}, V_{CE} = 10 \text{ V}$		75		
$I_C = 150 \text{ mA}, V_{CE} = 10 \text{ V}$		100	300	
$I_C = 300 \text{ mA}, V_{CE} = 10 \text{ V}$		35		
Collector-Emitter Saturation Voltage	V _{CE(sat)}		0.40	V
$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$	▼ GE(sat)		0.10	,
Base-Emitter Saturation Voltage	V _{BE(sat)}	0.80	1.25	V
$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$	▼BE(sat)	0.00	1.25	•
DYNAMIC CHARACTERISTICS				
Forward Current Transfer Ratio	b.	60	300	
$I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}, f = 1.0 \text{ kHz}$	h _{fe}	60	300	
Forward Current Transfer Ratio, Magnitude	lhr. l	2.0	10	
$I_C = 20 \text{ mA}, V_{CE} = 10 \text{ V}, f = 100 \text{ MHz}$	h _{fe}	2.0	10	
Small-Signal Common Emitter Input Impedance	h: -	1.5	9.0	kΩ
$I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}, f = 1.0 \text{ kHz}$	h _{ie}	1.5	3.0	K22
Small-Signal Common Emitter Output Admittance	h		50	μhmo
$I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}, f = 1.0 \text{ kHz}$	h _{oe}		30	μιιιιο
Open Circuit Output Capacitance	Calaa		8.0	pF
$V_{CB} = 10 \text{ V}, I_{E} = 0, 100 \text{ kHz} \le f \le 1.0 \text{ MHz}$	C _{obo}		0.0	ρı
Noise Figure	NF		8.0	dB
$I_C=100~\mu A,~V_{CE}=10~V,~f=1.0~kHz,~R_G=1.0~k\Omega$	INI		0.0	uБ
SWITCHING CHARACTERISTICS				
Turn-On Time (Saturated)	t		45	ns
(Reference MIL-PRF-19500/421, figure 7)	^t on	<u> </u>	40	115
Turn-Off Time (Saturated)	t _{off}		300	ns
(Reference MIL-PRF-19500/421, figure 8)	7011		000	110
Pulse Response (Non-Saturated)	t _{on +} t _{off}		18	ns
(Reference MIL-PRF-19500/421, figure 9)	011 + 011	1		
Collector-Emitter Non-Latching Voltage	V_{CEO}	40		V
Compositor Entition Factoring Voltage	1 *0=0	10		"



PACKAGE DIMENSIONS





Ltr	Dimensions				Notes
	Inch		Millimeters		
	Min	Max	Min	Max	
Α	.240	.290	6.10	7.37	
В	.115	.160	2.92	4.06	
С	.030	.080	0.76	2.03	
D	.003	.006	0.08	0.15	4
Е	.005	.035	0.13	0.89	
F	.010	.019	0.25	0.48	4, 6

Ltr	Dimension				Notes
	Inch		Millimeters		
	Min	Max	Min	Max	
G	.100 TP		2.54 TP		6,7
Н	-	.050	-	1.27	
J	-	.015	-	0.38	5
K	.050 TP		1.27 TP		6,7
L	.070	.250	1.78	6.35	3,4
М	.260	.650	6.60	16.51	

NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for general information only.
- 3. Maximum limit of this dimension does not apply to device supplied in a carrier.
- 4. All six leads.
- 5. Lead dimensions are uncontrolled in this zone.
- 6. Dimensions "F", "G", and "K" to be measured in zone "H".
- 7. Leads within .005 inch (0.13 mm) total of true position (TP) at "H" with maximum material condition.
- 8. In accordance with ASME Y14.5M, diameters are equivalent to Φx symbology.